#### **Data Sheet**



#### AFBR-1528CZ and AFBR-2528CZ

# DC to 10-Mbaud Versatile Link Fiber **Optic Analog Transmitter and Digital Receiver** for 1-mm POF and 200-µm PCS



#### **Description**

The AFBR-1528CZ analog transmitter utilizes a 650-nm LED source, and the AFBR-2528CZ receiver consists of an IC with an integrated photodiode that provides a TTL logic family compatible output.

AFBR-2528CZ devices have inverted output signals, which means that light\_on leads to Data\_out low.

The transmitter and receiver housing is designed to efficiently couple into 1-mm polymer optical fiber (POF) and 200-µm diameter plastic-clad silica (PCS). Links up to 58m are supported with 1-mm POF and up to 500m with 200-µm PCS.

A link with AFBR-1528CZ and AFBR-2528CZ enables operating temperatures up to +95°C.

The transmitter and receiver are 4-pin devices, packed in Versatile Link housings. Versatile Link components can be interlocked (N-plexed together) to minimize space and to provide dual connections with the duplex connectors. Various simplex and duplex connectors, as well as POF cables, are available for Versatile Link components.

#### **Available Transmitter Option**

Horizontal Package	AFBR-1528CZ

#### **Available Receiver Option**

Horizontal Package	AFBR-2528CZ

#### **Features**

- RoHS compliant
- Data transmission at signal rates from DC up to 10 Mbaud
- Up to 58 meters distance with 1-mm POF and up to 500 meters with 200-µm PCS
- Operating temperature range of -40°C to +95°C
- Compatible with the Broadcom Versatile Link family of connectors, for easy termination of fiber

## **Applications**

- Industrial control and factory automation
- Optical transmitter and receiver for 10-Mbaud systems and below
- Serial field buses
- Intra-system links; board-to-board, rack-to-rack
- Extension of RS-232 and RS-485
- High voltage isolation
- Elimination of ground loops
- Reduction of voltage transient susceptibility
- Drivers and inverters

#### **Application Literature**

Versatile Link Family: Application Note 1035 (AV02-0730EN).

## **Package and Handling Information**

The compact Versatile Link package is made of a flame retardant material and uses the same pad layout as a standard, eight-pin dual-inline package. Horizontal packages are available. These low-profile Versatile Link packages are stackable and are enclosed to provide a dust-resistant seal. Snap action simplex, simplex latching, duplex, and duplex latching connectors are offered with simplex or duplex cables.

#### **Package Housing Color**

Versatile Link components and simplex connectors are color coded to eliminate confusion when making connections. Receiver packages are black, and transmitters are gray.

#### **Handling**

Versatile Link components are auto-insertable. When wave soldering is performed with Versatile Link components, the optical port plug should be left in to prevent contamination of the port. Do not use reflow solder processes (for example, infrared reflow or vapor-phase reflow). Non-halogenated water soluble fluxes (for example, 0% chloride), not rosin-based fluxes, are recommended for use with Versatile Link components.

Versatile Link components are moisture-sensitive devices and are shipped in a moisture sealed bag. If the components are exposed to air for an extended period of time, they may require a baking step before the soldering process. Refer to the special labeling on the shipping tube for details.

# Recommended Chemicals for Cleaning/Degreasing

Alcohols: methyl, isopropyl, isobutyl Aliphatics: hexane, heptanes Other: soap solution, naphtha

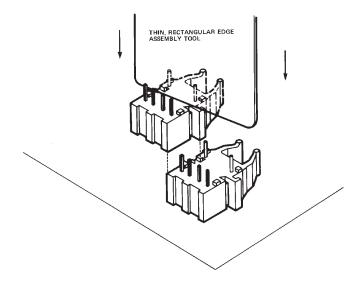
Do not use partially halogenated hydrocarbons such as 1,1,1 trichloroethane, ketones such as MEK, acetone, chloroform, ethyl acetate, methylene dichloride, phenol, methylene chloride, or N-methylpyrolldone. Broadcom does not recommend the use of cleaners that use halogenated hydrocarbons because of their potential environmental harm.

## Interlocked (Stacked) Assemblies

Horizontal packages can be stacked by placing units with pins facing upward. Initially engage the interlocking mechanism by sliding the L bracket body from above into the L slot body of the lower package. Use a straight edge, such as a ruler, to bring all stacked units into uniform alignment. This technique prevents potential harm that could occur to the fingers and hands of assemblers from the package pins. Stacked horizontal packages can be disengaged if necessary. Repeated stacking and unstacking causes no damage to individual units.

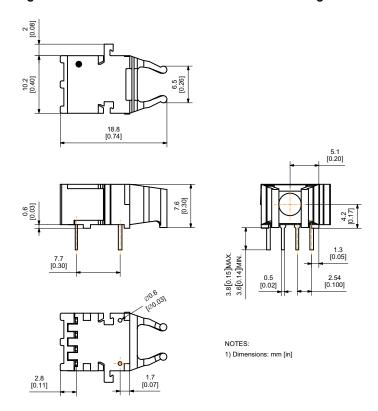
It is recommended to interlock (stack) no more than four compatible housings together.

Figure 1: Interlocked (Stacked) Horizontal Packages



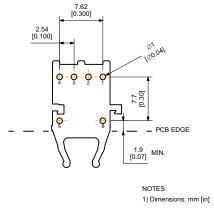
#### **Mechanical Dimensions**

Figure 2: Mechanical Dimensions - Horizontal Packages



# Versatile Link Printed Board Layout Dimensions

Figure 3: PCB Dimensions - Horizontal Packages



Footprint - TOP VIEW

### Regulatory Compliance (AFBR-1528CZ/AFBR-2528CZ)

Feature	Test Method	Performance
Electrostatic Discharge (ESD) to the Electrical Pins Human Body Model	MIL-STD-883 Method 3015	Min ± 2000V
Eye Safety <sup>a</sup>	IEC 60825-1,-2	Class 1

a. Valid for optical transmitter AFBR-1528CZ only.

#### Process Compatibility (AFBR-1528CZ/AFBR-2528CZ)

Parameter	Symbol	Min.	Typical	Max.	Unit
Solder Environment <sup>a, b</sup>	T <sub>SOLD</sub>	_	_	260 <sup>c</sup>	°C
	t <sub>SOLD</sub>	_	_	10 <sup>d</sup>	sec

- a. 1.6 mm below seating plane.
- b. Product is Moisture Sensitive Level 3.
- c. Maximum temperature refers to peak temperature.
- d. Maximum time refers to time spent at peak temperature. To guard against solder process fluctuations, the recommended nominal soldering time is 5 seconds.

#### 10-Mbaud Link Performance (AFBR-1528CZ/AFBR-2528CZ)

The optical link performance for operating temperatures up to +95°C is guaranteed only with transmitter AFBR-1528CZ (>20 mA forward peak current).

Parameter	Min.	Max.	Unit	Condition
Link Distance with Extra-Low Loss POF Cable <sup>a</sup>	0.1	58	m	-40°C to +95°C
Link Distance with 200-µm PCS Cable <sup>b</sup>	0.1	500	m	-40°C to +95°C

a. Polymer optical fiber (POF) is AFBR-HUXYYYZ or HFBR-EXXYYYZ for operating temperatures up to +85°C. Worst-case fiber attenuation (0.23 dB/m at 650 nm) is used for distance calculation.

#### Pin Description: Transmitter AFBR-1528CZ

Fiber port faces front, pins downward, 1 = Rightmost pin to 4 = Leftmost pin.

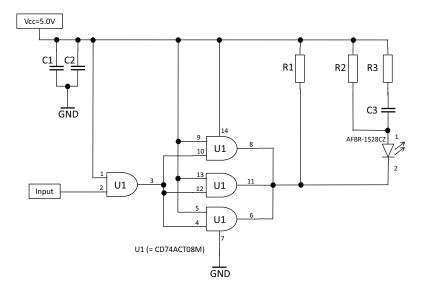
Pin	Name	Function/Description
1	Anode	LED anode.
2	Cathode	LED cathode.
3	Pin	No function, physical pin available, recommended to signal GND.
4	Pin	No function, physical pin available, recommended to signal GND.
5	Housing Pin <sup>a</sup>	Physical pin available, recommended to chassis GND.
8	Housing Pin <sup>a</sup>	Physical pin available, recommended to chassis GND.

a. Pins 5 and 8 are for mounting and retaining purposes. Make sure that they are electrically connected to chassis GND.

b. Plastic-clad silica (PCS) fiber. A worst-case attenuation of 12 dB/km (at 650 nm) is used for distance calculation.

This is an inverting circuit; thus, the LED is off in case of INPUT DATA high. Therefore, an inverting receiver, such as AFBR-2528CZ, should be used accordingly.

Figure 4: Recommended Drive Circuit



**NOTE:**  $I_{F,on} = 30 \text{ mA nominal at } T_A = 25^{\circ}\text{C}; V_{CC} = 5.0\text{V}.$ 

	Value	Tolerance
R1	2 kΩ	5%
R2	100Ω	1%
R3	15Ω	1%
C1	0.1 μF	20%
C2	10 μF	20%
C3	120 pF	5%

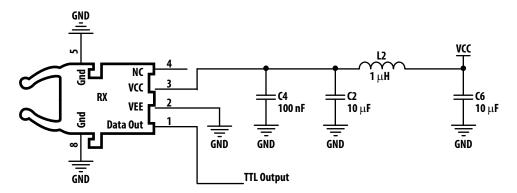
## Pin Description: Receiver AFBR-2528CZ

Fiber port faces front, pins downward, 1 = Rightmost pin to 4 = Leftmost pin.

Pin	Name	Function/Description
1	Data Out <sup>a, b</sup>	Data output.
2	V <sub>EE</sub>	Ground.
3	V <sub>CC</sub>	Power Supply 3.3V ± 5% or 5V ± 5%.
4	Pin <sup>c</sup>	No function, physical pin is available, recommended to signal GND.
5	Housing Pin <sup>d</sup>	Physical pin is available, recommended to chassis GND.
8	Housing Pin <sup>d</sup>	Physical pin is available, recommended to chassis GND.

- a. TTL compatible data output.
- b. Light on at the receiver input will lead to a "low" output signal and light off will lead to a "high" output signal.
- c. It is recommended to connect this pin to signal GND.
- d. Pins 5 and 8 are for mounting and retaining purposes and should be connected to chassis GND.

### **Recommended Application Circuit**



# **AFBR-1528CZ Analog Transmitter**

The AFBR-1528CZ analog transmitter utilizes a 650-nm LED source in a housing that is designed to efficiently couple into 1-mm polymer optical fiber (POF) or 200-µm plastic-clad silica (PCS). Links up to 58 meters are supported with 1-mm POF. Links up to 500 meters are supported with 200-um PCS.

#### **Absolute Maximum Ratings (AFBR-1528CZ)**

Parameter	Symbol	Min.	Max.	Unit
Storage and Operating Temperature	T <sub>S,O</sub>	-40	95	°C
Transmitter Peaking Forward Input Current <sup>a</sup>	I <sub>F,PK</sub>	_	45	mA
Transmitter Short-Term Peaking Forward Input Current <sup>b</sup>	I <sub>F, PKshort</sub>	_	80	mA
Transmitter Average Forward Input Current	I <sub>F,AVG</sub>	_	30	mA
Transmitter Reverse Input Voltage	V <sub>R</sub>	_	3	V

a. For I<sub>F,PK</sub> > 30 mA, the duty factor must maintain  $\leq$ 30 mA I<sub>F,AVG</sub> and pulse width  $\leq$ 1  $\mu$ s.

#### **Recommended Operating Conditions (AFBR-1528CZ)**

Parameter	Symbol	Min.	Max.	Unit
Ambient Temperature <sup>a, b</sup>	T <sub>A</sub>	-40	95	°C
Transmitter Average Forward Input Current <sup>a</sup>	I <sub>F,AVG</sub>	3	30	mA
Signaling Rate <sup>a, c</sup>	f <sub>s</sub>	DC	10	Mbaud

a. Recommended operating conditions are those values outside of which functional performance is not intended, device reliability is not implied, and damage to the device may occur over an extended period of time. See the reliability data sheet for specific reliability performance.

b. Measured at the housing.

c. Using the driver circuit in Figure 4 (without peaking and clamping of the electrical input signal).

b. The maximum short-term peaking forward current to improve the rise time or to enhance the signaling rate must not exceed 5 ns. Applying a short-term peaking forward current must not result in exceeding a 30-mA average forward current.

# **Electrical and Optical Characteristics (AFBR-1528CZ)**

TA = -40°C to +95°C unless otherwise stated.

Parameter	Symbol	Min.	Typical	Max.	Unit	Conditions	Notes
Peak Output Power, 1-mm POF, 30 mA	P <sub>T</sub>	<del>-</del> 6	-1	2	dBm	I <sub>F,DC</sub> = 30 mA	a, b, c
Peak Output Power, 200m PCS, 30 mA	P <sub>T</sub>	-18	-12	-9	dBm	I <sub>F,DC</sub> = 30 mA	a, b, c
Peak Output Power, 1-mm POF, 10 mA	P <sub>T</sub>	-11	-6	-3	dBm	I <sub>F,DC</sub> = 10 mA	a, b, c
Peak Output Power, 1-mm POF, 5 mA	P <sub>T</sub>	-14	-9	-6	dBm	I <sub>F,DC</sub> = 5 mA	a, b, c
Peak Output Power, 1-mm POF, 3 mA	P <sub>T</sub>	-16	-11	-8	dBm	I <sub>F,DC</sub> = 3 mA	a, b, c
Optical Power Temperature Coefficient	$\Delta P_T / \Delta T$	_	-0.01	_	dB/K	–40°C to +25°C	С
		_	-0.02	_	dB/K	+25°C to +95°C	С
Peak Emission Wavelength	λ <sub>P</sub>	630	650	685	nm	_	С
Peak Emission Wavelength Temperature Coefficient	Δλ/ΔΤ	_	0.16	_	nm/K	_	С
Spectral Width	FWHM	_	20	_	nm	_	С
Forward Voltage	V <sub>F</sub>	1.4	_	2.3	V	I <sub>F,DC</sub> = 3 mA to 30 mA	_
Forward Voltage Temperature Coefficient	$\Delta V_F/\Delta T$	_	-2.8	_	mV/K	-40°C to +25°C	С
I <sub>F,DC</sub> = 30 mA		_	-1.1	_	mV/K	+25°C to +95°C	С
Reverse Input Breakdown Voltage	_	9	20	_	V	_	С
Diode Capacitance	_	_	30	70	pF	_	С
Optical Rise Time (20% to 80%)	t <sub>r</sub>	_	3	20	ns	_	c, d
Optical Fall Time (80% to 20%)	t <sub>f</sub>	_	3	20	ns	_	c, d

a. Optical power measured with the polished connector end face at the end of 0.5 meters of 1-mm diameter POF with a numerical aperture (NA) of 0.5, or of 200- $\mu$ m diameter PCS, with NA = 0.37.

- b. Minimum average output power specification value includes a degradation margin of 1dB.
- c. Typical values are mean values measured at  $T_A$  = 25 $^{\circ}$ C.
- d. Using the drive circuit in Figure 4 for  $I_{F,DC}$  = 30 mA;  $V_{CC}$  = 5.0V.

Figure 5: Typical Forward Voltage vs. Drive Current

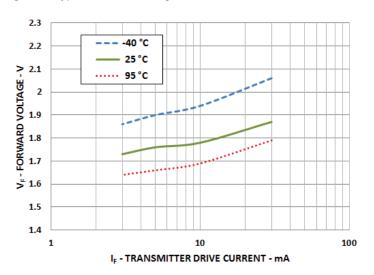
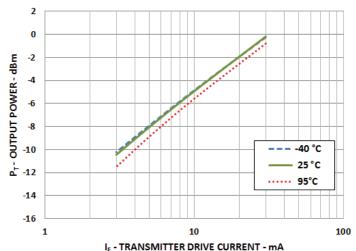


Figure 6: Typical Optical Output Power, 1-mm POF vs. Drive Current



#### **AFBR-2528CZ Receiver**

The AFBR-2528CZ receiver consists of a digitalizing IC with an integrated photodiode to produce an output level that is compatible with TTL logic. The integrated photodiode and the receiver's amplifier use a fully differential approach with an active and passive area for improved EMI performance. Within the specified ranges, the AFBR-2528CZ devices support a BER <10E-9.

#### **Absolute Maximum Ratings (AFBR-2528CZ)**

Parameter	Symbol	Min.	Typical	Max.	Unit
Storage and Operating Temperature <sup>a</sup>	T <sub>S,O</sub>	-40	_	95	°C
Relative Humidity <sup>a</sup>	RH	0	_	85	%
Supply Voltage <sup>a</sup>	V <sub>CC</sub>	-0.5	_	6	V
Data Output Current <sup>a</sup>	Io	_	_	10	mA

a. Absolute maximum ratings are those values beyond which damage to the device can occur if these limits are exceeded for other than a short period of time.

#### **Recommended Operating Conditions (AFBR-2528CZ)**

Parameter	Symbol	Min.	Typical	Max.	Unit
Ambient Temperature <sup>a, b</sup>	T <sub>A</sub>	-40	25	95	°C
Supply Voltage <sup>a</sup>	V <sub>CC</sub>	3.135	3.3	3.465	V
		4.75	5	5.25	V
Data Rate <sup>a</sup>	_	DC	_	10	Mbaud

a. Recommended operating conditions are those values outside of which functional performance is not intended, device reliability is not implied, and damage to the device may occur over an extended period of time. See the reliability data sheet for specific reliability performance.

b. Measured at the housing.

#### **Receiver Electrical Characteristics (AFBR-2528CZ)**

 $T_A = -40$ °C to +95°C,  $V_{CC} = 3.3V \pm 5\%$  or  $5V \pm 5\%$ .

Parameter	Symbol	Min.	Typical	Max.	Unit
Supply Current <sup>a</sup>	I <sub>CC</sub>	_	6	10	mA
Data Output Voltage – Low <sup>b</sup>	V <sub>OL</sub>	-0.3	_	0.4	V
Data Output Voltage – High <sup>b</sup>	V <sub>OH</sub>	2.5	_	V <sub>CC</sub> + 0.3	V
Rise Time (10% to 90%) <sup>c</sup>	t <sub>R</sub>	_	_	10	ns
Fall Time (90% to 10%) <sup>c</sup>	t <sub>F</sub>	_	_	10	ns
Pulse Width Distortion <sup>c, d, e, f</sup>	PWD	-30	_	30	ns
Propagation Delay <sup>c, d</sup>	t <sub>D</sub>	_	_	60	ns
Propagation Skew <sup>c, d, g</sup>	t <sub>skew</sub>	_	_	20	ns
V <sub>CC</sub> Level to Deactivate POR <sup>a, h</sup>	V <sub>POR_DEACT</sub>	_	2.8	_	V
V <sub>CC</sub> Level to Activate POR <sup>a, h</sup>	V <sub>POR_ACT</sub>	_	2.6	_	V
POR Deactivate Delay Time <sup>a, h</sup>	t <sub>POR_DEACT_DEL</sub>	_	100	_	μs

- a. Typical values are mean values measured at  $T_A$  = 25°C and 5V.
- b. Standard TTL output.
- c. Measured with  $R_1 = 5 \text{ k}\Omega$  and  $C_1 = 20 \text{ pF}$ .
- d. Guaranteed only if an optical input signal is generated by AFBR-1528CZ, with ideal alignment to the photodiode using a 1-mm POF (NA =
- e. Optical input of 10-Mbaud PRBS-7 pattern and 50% duty cycle. Optical input rise time (10% to 90%) ≤20 ns; optical input fall time (90% to 10%) ≤20 ns.
- f. Pulse width is measured at a 50% threshold using a rising edge trigger and PRBS-7 pattern.
- g. Only valid for the same input signal characteristics and environmental conditions. The optical input power must be
- h. The power-on reset (POR) is active below V<sub>POR DEACT</sub>. Once V<sub>POR DEACT</sub> is reached, the POR remains active for t<sub>POR DEACT DEL</sub>. During power-down, POR starts at V<sub>POR ACT</sub>. See Figure 7.

#### **Receiver Optical Characteristics (AFBR-2528CZ)**

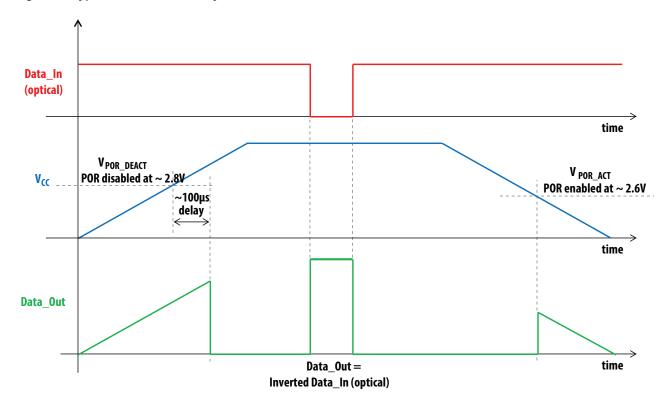
 $T_A = -40$ °C to +95°C,  $V_{CC} = 3.3V \pm 5\%$  or  $5V \pm 5\%$ .

Parameter	Symbol	Min.	Typical	Max.	Unit
Input Optical Power POF (Peak) <sup>a</sup>	P <sub>IN</sub>	-24	_	1	dBm
Input Optical Power PCS (Peak) <sup>b</sup>	P <sub>IN</sub>	-26	_	-2	dBm
Input Optical Power Off-State POF <sup>a</sup>	P <sub>IN_Off</sub>	-40	_	_	dBm
Input Optical Power Off-State PCSb	P <sub>IN_Off</sub>	-43	_	_	dBm
Optical Spectrum Range	λ	630	_	685	nm

- a. Measured at the end of a 0.5m POF (1 mm, 0.5 NA) with a large area optical detector.
- b. Measured at the end of a 0.5m PCS (200 µm, 0.37 NA) with a large area optical detector.

# **Power-On Reset Functionality**

Figure 7: Typical POR Functionality



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